# **MSA-0636**

# Cascadable Silicon Bipolar MMIC Amplifiers



# **Data Sheet**

### **Description**

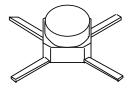
The MSA-0636 is a high performance silicon bipolar Monolithic Microwave Integrated Circuit (MMIC) housed in a cost effective, microstrip package. This MMIC is designed for use as a general purpose  $50\Omega$  gain block. Typical applications include narrow and broad band IF and RF amplifiers in commercial and industrial applications.

The MSA-series is fabricated using Avago's 10 GHz  $f_T$ , 25 GHz  $f_{MAX}$ , silicon bipolar MMIC process which uses nitride self-alignment, ion implantation, and gold metallization to achieve excellent performance, uniformity and reliability. The use of an external bias resistor for temperature and current stability also allows bias flexibility.

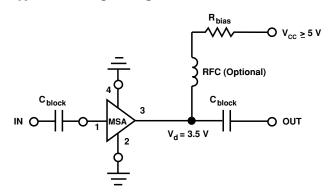
### **Features**

- Cascadable  $50\Omega$  Gain Block
- Low Operating Voltage: 3.5 V Typical V<sub>d</sub>
- 3 dB Bandwidth: DC to 0.9 GHz
- High Gain:
   19.0 dB Typical at 0.5 GHz
- Low Noise Figure:
   2.8 dB Typical at 0.5 GHz
- · Cost Effective Ceramic Microstrip Package

## 36 micro-X Package



### **Typical Biasing Configuration**



## **MSA-0636 Absolute Maximum Ratings**

Parameter	Absolute Maximum <sup>[1]</sup>					
Device Current	50 mA					
Power Dissipation <sup>[2,3]</sup>	200 mW					
RF Input Power	+13 dBm					
Junction Temperature	150°C					
Storage Temperature <sup>[4]</sup>	−65 to 150°C					

Thermal Resistance <sup>[2,5]</sup> :	
$\theta_{\rm jc} = 155^{\circ}{ m C/W}$	

#### Notes

- 1. Permanent damage may occur if any of these limits are exceeded.
- 2.  $T_{CASE} = 25$ °C.
- 3. Derate at  $6.5 \text{ mW/}^{\circ}\text{C}$  for  $T_C > 169^{\circ}\text{C}$ .
- 4. Storage above +150  $^{\circ}\mathrm{C}$  may tarnish the leads of this package making it difficult to solder into a circuit.
- 5. The small spot size of this technique results in a higher, though more accurate determination of  $\theta_{jc}$  than do alternate methods.

## Electrical Specifications<sup>[1]</sup>, $T_A = 25^{\circ}C$

Symbol	Parameters and Test Conditions:	Units	Min.	Тур.	Max.	
GP	Power Gain $( S_{21} ^2)$	f = 0.1  GHz	dB	19.0	20.5	22.0
$\Delta G_{ m P}$	Gain Flatness	f = 0.1  to  0.5  GHz	dB		±0.7	±1.0
f <sub>3 dB</sub>	3 dB Bandwidth		GHz		0.9	
VSWR	Input VSWR $f = 0.1 \text{ to } 1.5 \text{ GHz}$				1.4:1	
vown	Output VSWR			1.3:1		
NF	$50~\Omega$ Noise Figure	f = 0.5  GHz	dB		2.8	4.0
P <sub>1 dB</sub>	Output Power at 1 dB Gain Compression	f = 0.5  GHz	dBm		2.0	
IP3	Third Order Intercept Point	f = 0.5  GHz	dBm		14.5	
$t_{\mathrm{D}}$	Group Delay	f = 0.5  GHz	psec		200	
$V_{\mathbf{d}}$	Device Voltage		V	3.1	3.5	3.9
dV/dT	Device Voltage Temperature Coefficient		mV/°C		-8.0	

### **Note:**

1. The recommended operating current range for this device is 12 to 30 mA. Typical performance as a function of current is on the following page.

## **Ordering Information**

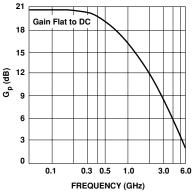
Part Numbers	No. of Devices	Comments		
MSA-0636-BLKG	100	Bulk		
MSA-0636-TR1G	1000	7" Reel		

MSA-0636 Typical Scattering Parameters	$(Z_0 = 50 \Omega, T_A = 25^{\circ}C, I_d = 16 \text{ mA})$
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Freq.	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>			S <sub>22</sub>			
GHz	Mag	Ang	dB	Mag	Ang	dB	Mag	Ang	Mag	Ang	k
0.1	.03	-178	20.5	10.59	171	-23.4	.068	5	.04	-44	1.05
0.2	.02	-177	20.3	10.31	161	-22.9	.071	8	.05	-68	1.04
0.3	.02	-164	20.0	9.96	152	-22.4	.076	14	.06	-87	1.04
0.4	.02	-116	19.6	9.55	144	-22.0	.079	19	.07	-104	1.03
0.5	.02	-100	19.2	9.08	136	-21.8	.081	21	.09	-114	1.04
0.6	.04	-89	18.7	8.59	128	-21.3	.086	24	.09	-123	1.04
0.8	.07	-96	17.7	7.66	115	-20.2	.098	29	.10	-140	1.03
1.0	.10	-108	16.6	6.79	103	-19.4	.107	31	.11	-156	1.02
1.5	.17	-134	14.2	5.13	79	-17.2	.138	30	.12	172	1.03
2.0	.24	-160	12.1	4.01	60	-15.8	.163	26	.12	148	1.04
2.5	.31	-178	10.3	3.26	48	-15.1	.175	27	.12	140	1.08
3.0	.37	166	8.7	2.72	34	-14.4	.190	24	.11	135	1.10
3.5	.42	151	7.4	2.33	21	-13.9	.203	19	.10	144	1.11
4.0	.46	139	6.2	2.04	9	-13.3	.216	16	.08	167	1.11
4.5	.48	126	5.1	1.81	-3	-12.8	.229	12	.08	-173	1.11
5.0	.52	110	4.2	1.62	-15	-12.2	.245	8	.09	-173	1.09

## Typical Performance, $T_A = 25^{\circ}C$

(unless otherwise noted)



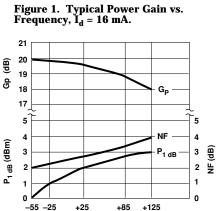


Figure 4. Output Power at 1 dB Gain Compression, NF and Power Gain vs. Case Temperature, f = 0.5 GHz,  $I_d = 16 \text{ mA}.$ 

TEMPERATURE (°C)

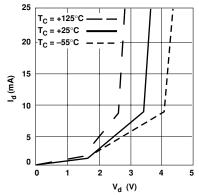


Figure 2. Device Current vs. Voltage.

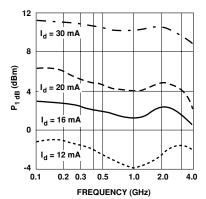


Figure 5. Output Power at 1 dB Gain Compression vs. Frequency.

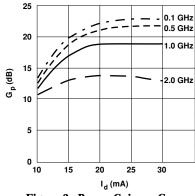


Figure 3. Power Gain vs. Current.

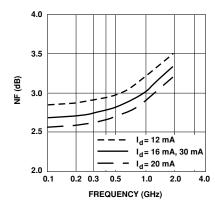
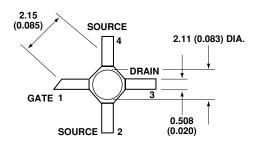
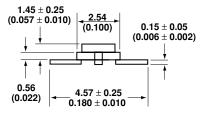


Figure 6. Noise Figure vs. Frequency.

## 36 micro-X Package Dimensions





#### Notes:

- 1. Dimensions are in millimeters (inches)
- 2. Tolerances: in .xxx =  $\pm$  0.005 mm .xx =  $\pm$  0.13

